IXYS

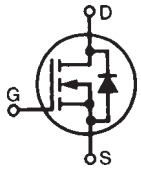
Advance Technical Information

TrenchT2™ GigaMOS™ Power MOSFET

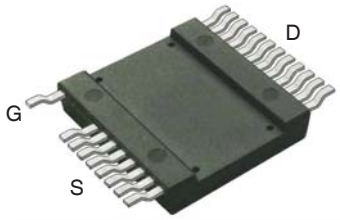
MMIX1T550N055T2

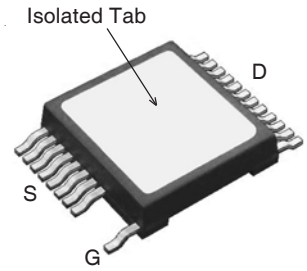
V_{DSS} = 55V
I_{D25} = 550A
$R_{DS(on)}$ ≤ 1.3mΩ

(Electrically Isolated Tab)



N-Channel Enhancement Mode
Avalanche Rated
Fast Intrinsic Diode





G = Gate D = Drain
S = Source

Symbol	Test Conditions	Maximum Ratings	
V_{DSS}	T_J = 25°C to 175°C	55	V
V_{DGR}	T_J = 25°C to 175°C, R_{GS} = 1MΩ	55	V
V_{GSM}	Transient	±20	V
I_{D25}	T_C = 25°C (Chip Capability)	550	A
I_{DM}	T_C = 25°C, Pulse Width Limited by T_{JM}	2000	A
I_A	T_C = 25°C	200	A
E_{AS}	T_C = 25°C	3	J
P_D	T_C = 25°C	830	W
T_J		-55 ... +175	°C
T_{JM}		175	°C
T_{stg}		-55 ... +175	°C
T_L	1.6mm (0.062 in.) from Case for 10s	300	°C
T_{SOLD}	Plastic Body for 10s	260	°C
V_{ISOL}	50/60 Hz, 1 Minute	2500	V~
F_C	Mounting Force	50..200 / 11..45	N/lb.
Weight		8	g

Symbol	Test Conditions (T_J = 25°C, Unless Otherwise Specified)	Characteristic Values Min.	Typ.	Max.	
BV_{DSS}	V_{GS} = 0V, I_D = 250μA	55			V
$V_{GS(th)}$	$V_{DS} = V_{GS}$, I_D = 250μA	1.8		3.8	V
I_{GSS}	V_{GS} = ±20V, V_{DS} = 0V			±200	nA
I_{DSS}	$V_{DS} = V_{DSS}$, V_{GS} = 0V			10	μA
	T_J = 150°C			1.5	mA
$R_{DS(on)}$	V_{GS} = 10V, I_D = 100A, Note 1			1.3	mΩ

Features

- Silicon Chip on Direct-Copper Bond (DCB) Substrate
- Isolated Substrate
  - Excellent Thermal Transfer
  - Increased Temperature and Power Cycling Capability
  - High Isolation Voltage (2500V~)
- 175°C Operating Temperature
- Very High Current Handling Capability
- Fast Intrinsic Diode
- Avalanche Rated
- Very Low $R_{DS(on)}$

Advantages

- Easy to Mount
- Space Savings
- High Power Density

Applications

- DC-DC Converters and Off-Line UPS
- Primary-Side Switch
- High Speed Power Switching Applications

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Symbol	Test Conditions (T_J = 25°C, Unless Otherwise Specified)	Characteristic Values Min.	Typ.	Max.	
g_{fs}	V_{DS} = 10V, I_D = 60A, Note 1	90	150		S
C_{iss}	V_{GS} = 0V, V_{DS} = 25V, f = 1MHz		40		nF
C_{oss}			4970		pF
C_{rss}			1020		pF
R_{Gi}	Gate Input Resistance		1.36		Ω
$t_{d(on)}$	**Resistive Switching Times**		45		ns
t_r	V_{GS} = 10V, V_{DS} = 0.5 • V_{DSS}, I_D = 200A		40		ns
$t_{d(off)}$	R_G = 1Ω (External)		90		ns
t_f			230		ns
$Q_{g(on)}$	V_{GS} = 10V, V_{DS} = 0.5 • V_{DSS}, I_D = 0.5 • I_{DSS}		595		nC
Q_{gs}			150		nC
Q_{gd}			163		nC
R_{thJC}				0.18	°C/W
R_{thCS}			0.05		°C/W

Source-Drain Diode

Symbol	Test Conditions (T_J = 25°C, Unless Otherwise Specified)	Characteristic Values Min.	Typ.	Max.	
I_S	V_{GS} = 0V			550	A
I_{SM}	Repetitive, Pulse Width Limited by T_{JM}			1700	A
V_{SD}	I_F = 100A, V_{GS} = 0V, Note 1			1.2	V
t_{rr}	I_F = 100A, V_{GS} = 0V		100		ns
I_{RM}	-di/dt = 100A/μs		5		A
Q_{RM}	V_R = 27.5V		250		nC

Note 1. Pulse test, t ≤ 300μs, duty cycle, d ≤ 2%.

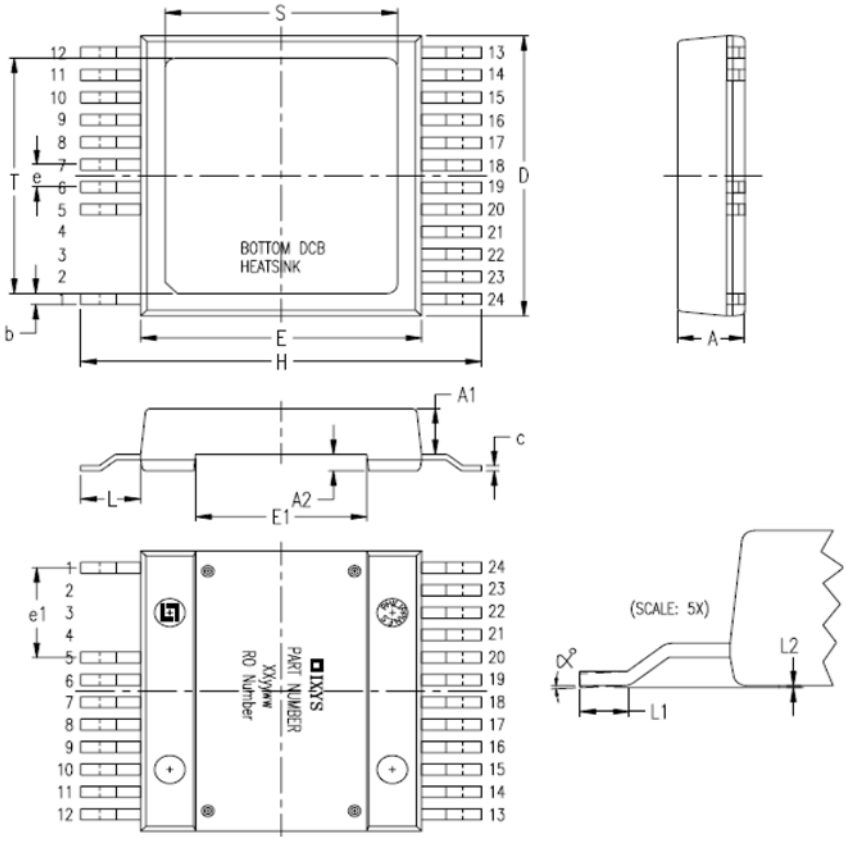
ADVANCE TECHNICAL INFORMATION

The product presented herein is under development. The Technical Specifications offered are derived from a subjective evaluation of the design, based upon prior knowledge and experience, and constitute a "considered reflection" of the anticipated result. IXYS reserves the right to change limits, test conditions, and dimensions without notice.

IXYS Reserves the Right to Change Limits, Test Conditions, and Dimensions.

IXYS MOSFETs and IGBTs are covered by one or more of the following U.S. patents: 4,835,592 4,850,072 4,881,106 4,931,844 5,017,508 5,034,796 5,049,961 5,063,307 5,187,117 5,237,481 5,381,025 5,486,715 6,162,665 6,259,123 B1 6,306,728 B1 6,404,065 B1 6,534,343 6,583,505 6,683,344 6,710,405 B2 6,710,463 6,727,585 6,759,692 6,771,478 B2 7,005,734 B2 7,063,975 B2 7,071,537 7,157,338B2

Package Outline



SYM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	.209	.224	5.30	5.70
A1	.154	.161	3.90	4.10
A2	.055	.063	1.40	1.60
b	.035	.045	0.90	1.15
c	.018	.026	0.45	0.65
D	.976	.994	24.80	25.25
E	.898	.915	22.80	23.25
E1	.543	.559	13.80	14.20
e	.079 BSC		2.00 BSC	
e1	.315 BSC		8.00 BSC	
H	1.272	1.311	32.30	33.30
L	.181	.209	4.60	5.30
L1	.051	.067	1.30	1.70
L2	.000	.006	0.00	0.15
S	.736	.760	18.70	19.30
T	.815	.839	20.70	21.30
α	0	4°	0	4°

PIN: 1 = Gate
5-12 = Source
13-24 = Drain

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IXYS:

MDD255-16N1 CPC1019N CPC1215G DSEI30-06A IXDF604SIATR IXYH82N120C3 LOC117S VBO40-16NO6 IXDD609SITR IXFA80N25X3 MDD26-12N1B IXDN602D2TR CS45-12IO1 IXDD614SITR IXFK64N60P3 IXFN200N10P IXGH32N170 IXTP4N65X2 IXTP62N15P IXDN602SITR IXYB82N120C3H1 MCC56-12IO1B MCO50-16IO1 CPC1301G DSEP15-06A IX4340UETR IXDD609D2TR IXFN170N65X2 IXYH25N250CHV DSEI30-10A